ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES®	© Co	terial Compo pyright 2005. IPC, Bannoc international and Pan-Amer	kburn, Illinois	. All rights reserv	tion with lower	level p	oarts, the	declarati	on encom	passes all lov	ver level mat	erials for wh	e: if the item is an assemb nich the manufacturer ha this declaration.		
1752-2 1.1	-	Web Site for Informat ://www.ipc.org/IPC-1							Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Informa						
Supplier Information															
Company Name *		Company Unique ID		Unique ID Au	uthority	Resp	onse Date) *	F	Response Doo	cument ID				
SEMTECH CORPORATIO	ON					2010-	03-24								
Contact Name * Title - Contact HILMY SOEDJADI							Email - Contact * hsoedjadi@semtech.com			Duplicate Contact -> Authorized Representative					
Authorized Representati HILMY SOEDJADI	ve *	Title - Representativ	e	Phone - Rep (805) 498-21	oresentative *		- Repres Ijadi@sei			Supplier Com	ments or UR	L for Additic	onal Information		
Requester Item Numbe	Requester Item Number Mfr Item Number			Mfr Item Name	Effectiv	ve Date	Version	Manufad	cturing Site	Weight *	UOM	Unit Type			
Alternate Recommendation				Very Low Input/ Very Low Drop					Malaysi	а	79.5869	mg	Each		
							Alternate Item Co		nments	nents					
Manufacturing Proces	ss In	formation													
Terminal Plating / Grid Array	Mater	ial	Terminal B	ase Alloy	J-STD-020 MSL Ra	iting	Peak Proc	ess Body	y Tempera	ture Max Time	e at Peak Tem	perature Nu	mber of Reflow Cycles		
Matte Tin (Sn) CU Alloy			,	260			260 C	C 30 seconds 3							
Comments															

Save the fields in this form to a file	Export Data	Import fields from a file into this form	Import Data	Clear all of the fields on this form	Reset Form	Lock the fields on this form to prevent chan	Look Cumption Fields
RoHS Material	Composition Declara	tion				Declaration Type	* Detailed
		limit of 0.1% by mass (100 thers (PBDE) and quantity	, .				ominated Biphenyls (PBB),
chromium, polybrominate excess of an applicable of gathered the information Company will rely on this completing this form, and certifications regarding the conditions of that agreen	ed biphenyls and/or polybrominated quantity limit, please indicate below it provides in this form using approp certification in determining the com I that Supplier may not have independent rein contributions to the part, and the nent, including any warranty rights a	which, if any, RoHS exemption you b priate methods to ensure its accuracy apliance of its products with European andently verified such information. Ho pose certifications are at least as comp	icted substance") in excess believe may apply. If the p y and that such information n Union member state laws bowever, in situations where prehensive as the certification that agreement, will be the s	of the applicable quantity limit bart is an assembly with lower I is true and correct to the best of that implement the RoHS Dire Supplier has not independentl on in this paragraph. If the Co ole and exclusive source of the	identified above. If a homogene- evel components, the declaration of its knowledge and belief, as of ctive. Company acknowledges to y verified information provided by mpany and the Supplier enter into a Supplier's liability and the Comp	eous material within the part cont n shall encompass all such comp f the date that Supplier complete that Supplier may have relied on y others, Supplier agrees that, at to a written agreement with response upany's remedies for issues that a	tains a RoHS restricted substance in ponents. Supplier certifies that it s this form. Supplier acknowledges that
RoHS Declaration	n * 1 - Item(s) does not contain	RoHS restricted substances per th	he definition above			Supplier Acceptance *	Accepted
	declared item does not cont Il applicable exemptions.	ain RoHS restricted substanc	es per the definition a	bove except for defined	RoHS exemptions, then s	select the corresponding re	esponse in the RoHS Declaration
Declaration Si	gnature						
		C 1 1 11 C (1 1)			· • • • • •	T 1: 10 11 1 4	D' i ll i

Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

Homogeneous Material Composition Declaration for Electronic Products

Subltem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

Item/SubItem Name			Homogeneous	Weight	Unit of			Level	Substance Category			Substance	CAS	Exempt	Weight		Tolerance		РРМ	
		Name		Material	weight	Measure			Levei	Substance Category				040	Lyempt	weight	Measure	-	+	
+	1 -1	DIE CHIP	+M -M	Silicon Die	2.88	mg	+C -	CS	Supplier		+S	-S	Silicon (Si)	7440-21-3		2.88	mg			
+	1 -1	LEAD FRAME	+M -M	CDA194	24.3332	mg	+C -	-C s	Supplier		+S	-S	Copper (Cu)	7440-50-8		23.7249	mg			
								_			+S	-s	Iron (Fe)	7439-89-6		0.5718	mg			
											+S	-s	Zinc (Zn)	7440-66-6		0.0292	mg			
											+S	-s	Phosphorous (P)	7723-14-0		0.0073	mg			
			+M -M	Silver spot platir	0.0896	mg	+C	CS	Supplier		+S	-s	Silver (Ag)	7440-22-4		0.0896	mg			
+	I -I	DIE ATTACH MATE	+M -M	2600AT	1.6411	mg	+C -	-C s	Supplier		+S	-S	Silver (Ag)	7440-22-4		1.2472	mg			
											+S	-s	Solventborne Epoxy Re	Proprietary		0.2872	mg			
											+S	-s	n-paraffinic HydroCarbo	Proprietary		0.1067	mg			
+	1 -1	WIRE BONDING	+M -M	Gold Wire	0.2541	mg	+C	CS	Supplier		+S	-S	Gold (Au)	7440-57-5		0.2541	mg			
+	1 -1	MOLD COMPOUND	+M -M	EME-G600	49.3612	mg	+C -	-C s	Supplier		+S	-S	Silica Fused	606076-86-0		42.7962	mg			
											+S	-s	Epoxy Resin	Proprietary		2.9617	mg			
											+S	-s	Epoxy, Cresol Novolac	29690-82-2		0.9872	mg			
											+S	-s	Phenol Resin	Proprietary		2.4681	mg			
											+S	-s	Carbon Black	1333-86-4		0.1481	mg			
+	-	PLATING - TIN	+M -M	Tin (Sn)	1.0277	mg	+C	CS	Supplier		+S	-S	Tin (Sn)	7440-31-5		1.0277	mg			